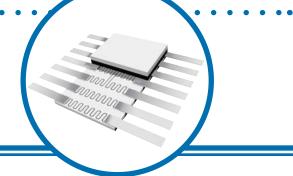
TaNFilm[®] Precision Flat Pack Networks



8900 Series

- Precision absolute and ratio tolerances available
- Qualified to MIL-R-83401 /03, /10 and /15
- Qualified to characteristics M, K and H
- Custom schematics readily available
- Absolute TCR to ±15ppm/°C



TaNFilm[®] resistor networks are designed for use in applications requiring a high degree of reliability, stability, tight tolerance and TCR tracking, and low noise. The sputtering process for resistor formation has been perfected to allow a continuous feed production line under high vacuum conditions, thus, insuring uniformity of properties between networks. Laser trimming makes tight ratios easily achievable. The gold plated copper leads are solid phase welded to a large area of gold conductor pads on the ceramic substrate assuring the most reliable termination and long term stability. The Tantalum Nitride resistor material is passivated for environmental protection insuring excellent performance far superior to military requirements.

Our TaNFilm[®] process enables us to manufacture networks containing different resistance values and still maintain tight tolerances and tracking characteristics. The nature of our photo-etch process makes it readily adaptable to meet each individual customer's needs. Custom circuit designs and special mechanical configurations can be easily achieved with a modest set up charge while maintaining our high standards of precision and reliability.

Schematic	Resistance Range (Ω)	Absolute Tolerance	Optional Ratio Tolerance	Absolute TCR (ppm/°C)	Tracking TCR (ppm/°C)	Element Power (mW)
	10 - 49.9 F		F, G	±50; ±100; ±300	±20	
	50.0 - 199	F, G, J	D, F, G	±25; ±50; ±100; ±300	±10	
Α	200 - 999	B, D, F, G, J	A, B, D, F, G	±25; ±50; ±100; ±300	±5	50
	1.0K - 100K	B, D, F, G, J	T, Q, A, B, D, F, G	±15; ±25; ±50; ±100; ±300	±5	
	101K - 200K	B, D, F, G, J	A, B, D, F, G	±25; ±50; ±100; ±300	±5	
	50 - 149	B, D, F, G, J	B, D, F, G	±300; ±100	±50	
	150 - 499	B, D, F, G, J	B, D, F, G	±300; ±100; ±50	±20	05
В	500 - 999	B, D, F, G, J	B, D, F, G	±25; ±50; ±100; ±300	±5	25
	1.0K - 150K	B, D, F, G, J	B, D, F, G	±15; ±25; ±50; ±100; ±300	±5	

Electrical Data







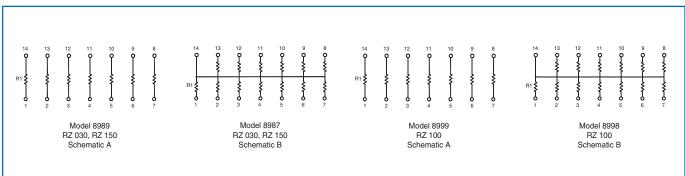
MIL-PRF-83401 Qualification Data

Specification	Size	Schematic	Resistance Range (Ω)	Absolute Tolerance (%)	Characteristic	
MIL-PRF-83401/03	14-Pin		20 - 121K	F, G, J	К, М	
MIL-PRF-83401/15		А, В	100 - 100K	B, D, F, G, J	Н, К, М	
MIL-PRF-83401/10	16-Pin	A, B	100 - 100K	B, D, F, G, J	Н, К, М	

Package Specification Data (MIL and Commercial)

Schematic	Package Power		Power Derating	Voltage Rating	Temperature Range	Substrate	Lead Finish	Noise	
Concinatio	14-pin	16-pin							
A	350	400	100% from 0°C to 70°C derated linearly to 0%	√PxR not to exceed 50V	-65°C to +125°C 99.6% Alumina	99.6% Alumina	Gold Plate (60/40 Sn/Pb <-300 available)	(60/40 Sn/Pb	<-30dB
В	325	375	at 125°C	exceed 50V					

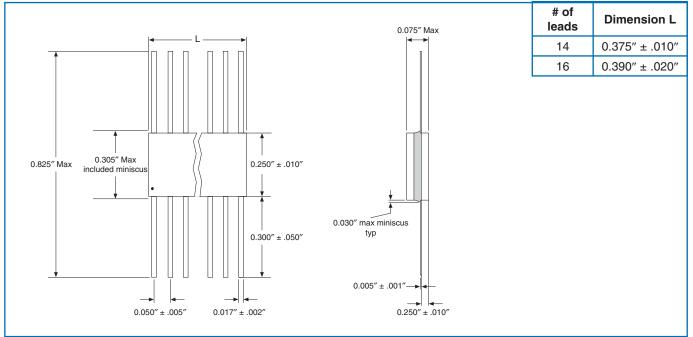
Schematics



TaNFilm[®] Precision Flat Pack Networks



Physical Data



Environmental Data

	MIL-PRF-83401 Limits (∆R%)				TaNFilm [®] Test Data (∆R%)		
Test per MIL-PRF-83401	М	к	Н	v	Мах	Typical	
Thermal Shock and Power Conditioning	0.7	0.7	0.5	0.25	0.1	0.02	
Low Temperature Operation	0.5	0.25	0.1	0.1	0.1	0.01	
Short Term Overload	0.5	0.25	0.1	0.1	0.05	0.01	
Terminal Strength	0.25	0.25	0.25	0.1	0.1	0.01	
Resistance to Solder Heat	0.25	0.25	0.1	0.2	0.1	0.02	
Moisture Resistance	0.5	0.5	0.4	0.25	0.1	0.03	
Shock	0.25	0.25	0.25	0.25	0.1	0.03	
Vibration	0.25	0.25	0.25	0.1	0.1	0.03	
Life	2.0	0.5	0.5	0.1	0.1	0.03	
High Temperature Exposure	1.0	0.5	0.2	0.1	0.1	0.03	
Low Temperature Storage	0.5	0.25	0.1	0.1	0.1	0.02	
25°C Double Load	2.0	0.5	0.5	0.1	0.05	0.03	

TaNFilm[®] Precision Flat Pack Networks



Commercial Ordering Data

Prefix	1001	в	F
	<u> </u>	7	:
Model 8987 = 14-pin Flat Pack, schematic B, gold terminations		:	:
8987SD = 14-pin Flat Pack, schematic B, 60/40 Sn/Pb terminations		:	:
8989 = 14-pin Flat Pack, schematic A, gold terminations 8989SD = 14-pin Flat Pack, schematic A, 60/40 Sn/Pb terminations		:	:
8998 = 16-pin Flat Pack, schematic B, gold terminations		:	÷
8998SD = 16-pin Flat Pack, schematic B, 60/40 Sn/Pb terminations	:		
8999 = 16-pin Flat Pack, schematic A, gold terminations 8999SD = 16-pin Flat Pack, schematic A, 60/40 Sn/Pb terminations	•	:	:
		:	÷
Absolute TCR · · · · · ·	:		
$01 = \pm 100 ppm/^{\circ}C; 02 = \pm 50 ppm/^{\circ}C; 03 = \pm 25 ppm/^{\circ}C; 11 = \pm 15 ppm/^{\circ}C$	•	:	:
Resistance .	:	:	:
Tresistance	• • • •	:	:
Standard 4-digit MIL resistance code Example: $1001 = 1000\Omega$; $50R0=50\Omega$:	:
		:	:
Absolute Tolerance · · · · · · · · · · · · · · · · · · ·	••••	•••	
$J = \pm 5\%$; $G = \pm 2\%$; $F = \pm 1.0\%$; $D = \pm 0.5\%$; $B = \pm 0.1\%$:
Optional Ratio Tolerance to R.			:
F = $\pm 1.0\%$; D = $\pm 0.5\%$; C = $\pm 0.25\%$; B = $\pm 0.1\%$; A = $\pm 0.05\%$; Q = $\pm 0.02\%$	6· T − +0 (11%	
$1 = \pm 1.0 / 0, D = \pm 0.0 / 0, O = \pm 0.20 / 0, D = \pm 0.1 / 0, R = \pm 0.00 / 0, Q = \pm 0.02 / 0$	<i>s</i> , <i>i</i> = ±0.0		

Custom schematics and screening available.

Screening available for non-QPL values and tolerances. Contact factory for ordering information.

MIL Screened Ordering Data (MIL-PRF-83401)

Prefix
Specification Sheet 03 = 14-pin Flat Pack 10 = 16-pin Flat Pack 15 = 14-pin HI REL Flat Pack
Characteristic •• • • • • • • • • • • • • • • • • •
Resistance
Standard 4-digit MIL resistance code Example: 1001 = 1000Ω; 50R0=50Ω
Absolute Tolerance
$J = \pm 5\%$; $G = \pm 2\%$; $F = \pm 1.0\%$; $D = \pm 0.5\%$; $B = \pm 0.1\%$
Schematic-

A = Isolated; B = Bussed Schematic

Standard lead termination is gold plate. Contact factory for optional 60/40 Sn/Pb solder dip finish.